

**ABSTRACT**

A device includes an electrical circuit carried by a carrier element, an electrically conductive structure being provided on a surface of the carrier element. In accordance with the invention the one or more components of the electrical circuit are arranged on the side of the electrically conductive structure facing the carrier element .

Such a device is more versatile in use and can be made more compact than is the case with conventional arrangements.

A method of producing such a device comprises the following steps:

- application of the electrically conductive structure to a temporary substrate ,
- mounting of further components of the electrical circuit on the electrically conductive structure,
- application of a composition forming the carrier element to the side of the temporary substrate carrying the said circuit parts, and
- removal of the temporary substrate.